

106012-1 ✓ ACTIVE

Z-PACK | Z-PACK 2mm HM

TE Internal #: 106012-1

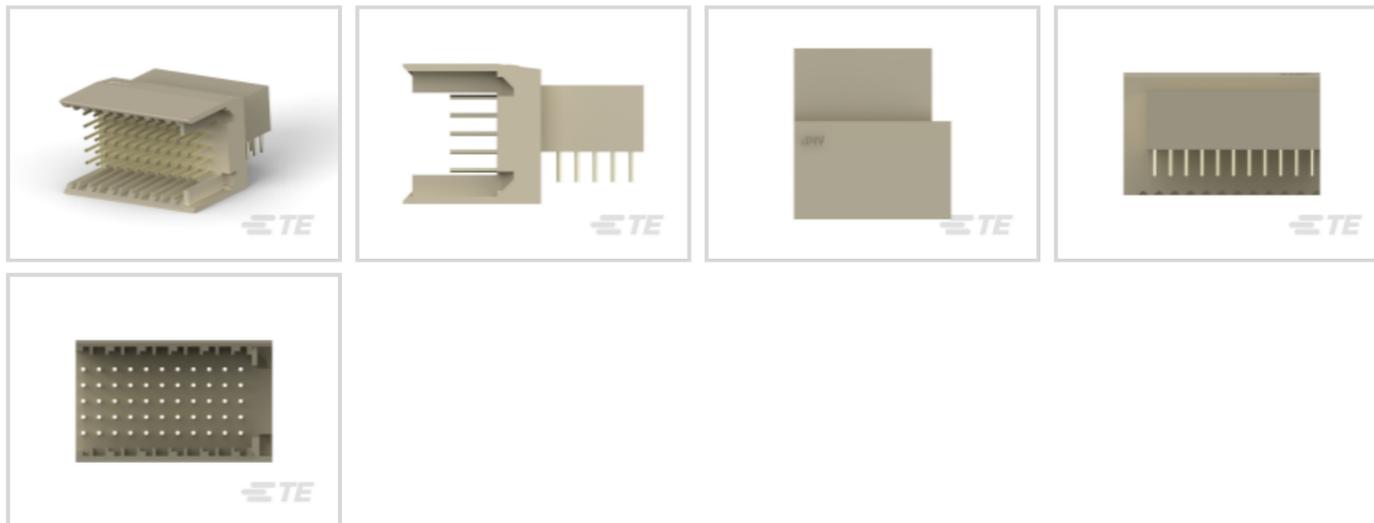
Hard Metric Backplane Connectors, PCB Mount Header,  $\leq 1$  Gb/s, 6 Column, 5 Row, Mezzanine, Board-to-Board, 55 Position, Z-PACK 2mm HM

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[Connectors >](#) [PCB Connectors >](#) [Backplane Connectors >](#) [Hard Metric Connectors >](#)

Hard Metric Backplane Male Connector: Right Angle, Coplanar, 2mm



PCB Connector Assembly Type: **PCB Mount Header**

Data Rate:  $\leq 1$  Gb/s

Number of Columns: **6**

Number of Rows: **5**

Backplane Architecture: **Mezzanine**

[All Hard Metric Backplane Male Connector: Right Angle, Coplanar, 2mm \(21\)](#)

## Features

### Product Type Features

Backplane Interface Type	2mm HM
PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

### Configuration Features

Number of Columns	6
Number of Rows	5
Backplane Architecture	Mezzanine
Number of Positions	55
PCB Mount Orientation	Right Angle

### Signal Characteristics



Crosstalk Version	Standard
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Data Rate	≤1 Gb/s
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### Contact Features

Contact Mating Area Length	5.2 mm
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Feedthrough Post Length	3.7 mm
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Contact Type	Pin
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Contact Underplating Material	Nickel
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PCB Contact Termination Area Plating Material	Tin-Lead
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Contact Base Material	Phosphor Bronze
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CompactPCI Designation	None
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Contact Mating Area Plating Material	Gold
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Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
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Contact Current Rating (Max)	.7 A
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### Termination Features

Termination Method to Printed Circuit Board	Through Hole - Press-Fit
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### Mechanical Attachment

Front Mating Level	Level 1
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Connector Mounting Type	Board Mount
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### Housing Features

Housing Material	Polyester - GF
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Centerline (Pitch)	2 mm[.078 in]
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Housing Color	Gray
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### Dimensions

Backplane Module Length	25 mm
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### Usage Conditions

Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
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### Operation/Application

Shielded	No
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Circuit Application	Power & Signal
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### Industry Standards

UL Flammability Rating	UL 94V-0
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AdvancedTCA Specified Product

No

### Packaging Features

Packaging Quantity

22

### Other

Comment

Warning: Card extender male connectors should not be used with cable connectors.

## Product Compliance

For compliance documentation, visit the product page on [TE.com](https://www.te.com)>

EU RoHS Directive 2011/65/EU

Not Compliant

EU ELV Directive 2000/53/EC

Compliant with Exemptions

China RoHS 2 Directive MIIT Order No 32, 2016

Restricted Materials Above Threshold

EU REACH Regulation (EC) No. 1907/2006

Current ECHA Candidate List: JUNE 2022 (224)  
 Candidate List Declared Against: JUNE 2022 (224)  
 SVHC > Threshold:  
 Pb (13% in Component Part)

**Article Safe Usage Statements:**

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Halogen Content

Not Low Halogen - contains Br or Cl &gt; 900 ppm.

Solder Process Capability

Not applicable for solder process capability

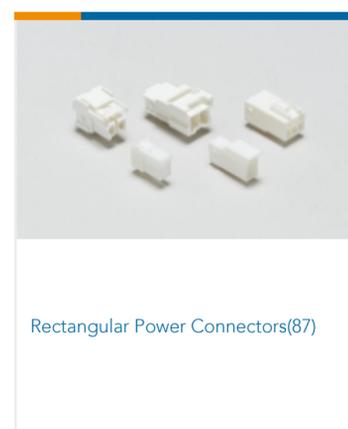
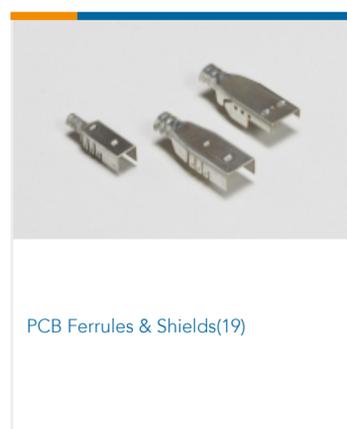
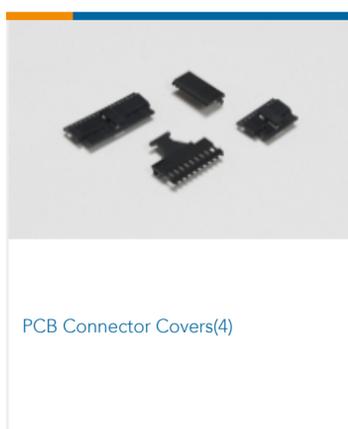
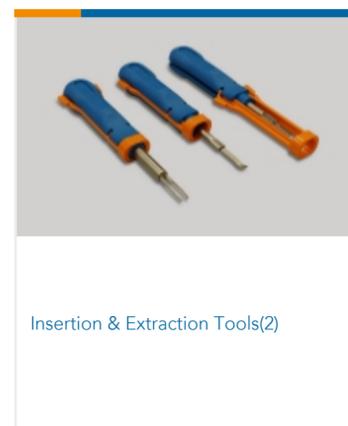
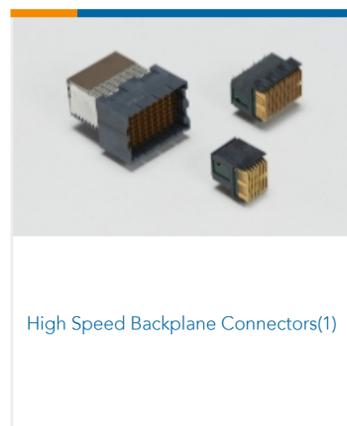
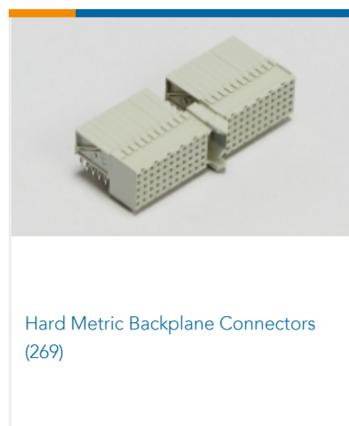
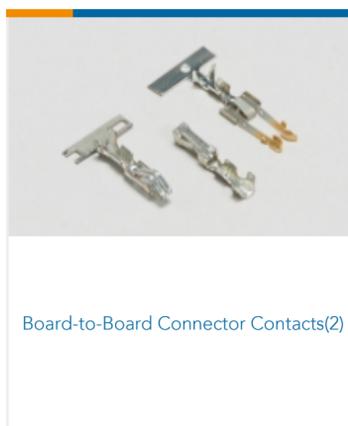
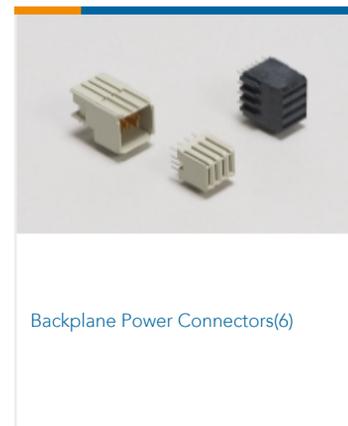
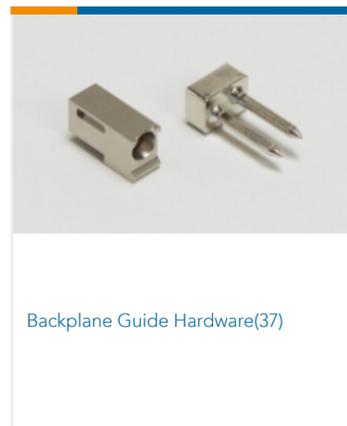
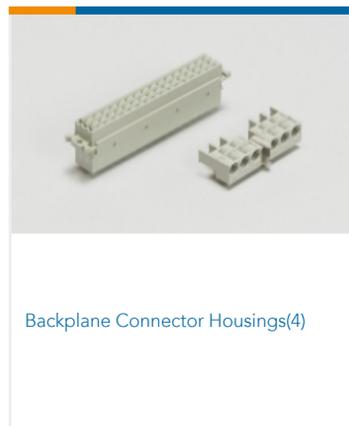
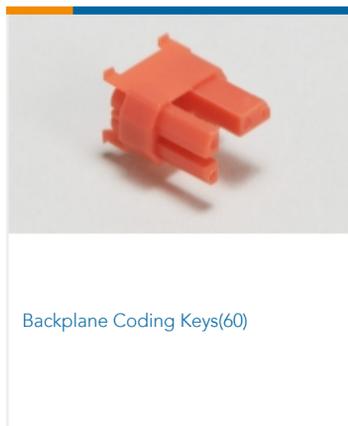
#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

## Compatible Parts



## Also in the Series | Z-PACK 2mm HM



## Documents

[Product Drawings](#)  
[Z-PACK/C RAMH. 55P.](#)

English

### CAD Files

[3D PDF](#)

English

[Customer View Model](#)



[ENG\\_CVM\\_106012-1\\_L1.2d\\_dxf.zip](#)

English

**Customer View Model**

[ENG\\_CVM\\_106012-1\\_L1.3d\\_igs.zip](#)

English

**Customer View Model**

[ENG\\_CVM\\_106012-1\\_L1.3d\\_stp.zip](#)

English

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### Product Specifications

[Application Specification](#)

English

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### Product Environmental Compliance

[MD\\_106012-1\\_12142017559\\_dmtec](#)

English

[MD\\_106012-1\\_12142017559\\_dmtec](#)

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